

System LSI (事)

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	DS System LSI
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	2009.4.20 ~ 2009.5.10
	<p>Process Development Integration</p> <ul style="list-style-type: none"> - SiO2/SiN, High-K/Metal Gate - Ultra Low-K - FEOL/BEOL Process Integration <p>Device Engineering</p> <ul style="list-style-type: none"> - Device, - Solid Device Physics <p>Unit Process & Equipment Development</p> <ul style="list-style-type: none"> - Photo-Lithography : Thick PR/Dry Film Process & Material - Etch : Dry Etch, Metal Wet Etch, Organic Etch - Thin Film : Metal, CVD, Implant - Cleaning, CMP <p>Design Infra Development</p> <ul style="list-style-type: none"> - DFM Engineering, Design Rule - Infra System <p>Product Engineering & Test</p> <p>Marketing & Customer Engineering</p> <ul style="list-style-type: none"> - Product Marketing, Technology Marketing - Customer Engineering (Technical Interface, Program Management) <p>Quality</p> <ul style="list-style-type: none"> - Customer interface, Quality system or engineering, Technical support - Process reliability, Device degradation modeling, Circuit reliability <p>: ()</p>
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	<p>http://www.sec.co.kr -> " "</p> <p>-</p>
	<p>1 : 2 : (/) 3 :</p>
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